# 2-5499206-9 - ACTIVE

## AMP-LATCH | AMP-LATCH Universal Headers

AMP-LATCH UNIVERSAL HEADERS

TE Internal #: 2-5499206-9 AMP-LATCH Universal Headers, Ribbon Cable Connectors, Wire-to-Board, 40 Position, 2.54mm [.1in] Centerline, Vertical, Through Hole - Solder

#### View on TE.com >

Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > Ribbon Cable Connectors >

Connector System: Wire-to-Board

Number of Positions: 40

Centerline (Pitch): 2.54 mm [.1 in]

PCB Mount Retention: Without

PCB Mount Orientation: Vertical

All AMP-LATCH UNIVERSAL HEADERS (525)



## Features

## **Product Type Features**

Connector Type	Header
Ribbon Cable Connector Header Type	Universal Ejection Pin Headers
Connector Mating Latch & Lock Type	Long
Connector Product Type	Connector Assembly
Connector System	Wire-to-Board
Connector & Housing Type	Plug
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Configuration Features Number of Positions	40
	40 Vertical
Number of Positions	

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Insulation Resistance	5000 MΩ
Operating Voltage	250 VAC
Body Features	
Connector Profile	Standard
Contact Features	
Mating Square Post Dimension	.64 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	2.54 μm[100 μin]
Contact Type	Pin
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Contact Mating Area Plating Material	Gold
Contact Shape & Form	Square
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Current Rating (Max)	1 A
Termination Features	
Round Termination Post & Tail Diameter	.64 mm[.025 in]
Termination Post & Tail Length	2.79 mm[.11 in]

Termination Method to	Printed Circuit Board
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Through Hole - Solder

Mating Alignment	With
PCB Mount Alignment	Without
Panel Mount Feature	Without
PCB Mount Retention	Without
Mating Alignment Type	Center
Mating Retention	With
Mating Retention Type	Ejection Latch
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	Glass Filled Nylon/Polyester
Housing Color	Blue
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	

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Shrouded End Dimension	3.81 mm[.15 in]
Connector Length	70.1 mm[2.76 in]
Connector Height	13.94 mm[.548 in]
PCB Thickness (Recommended)	1.57 mm[.062 in]
Row-to-Row Spacing	2.54 mm[.1 in]
Usage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	18
Packaging Method	Tray
Other	
Comment	Mates with Receptacles

## Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2021 (211) Candidate List Declared Against: JAN 2021 (211) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent

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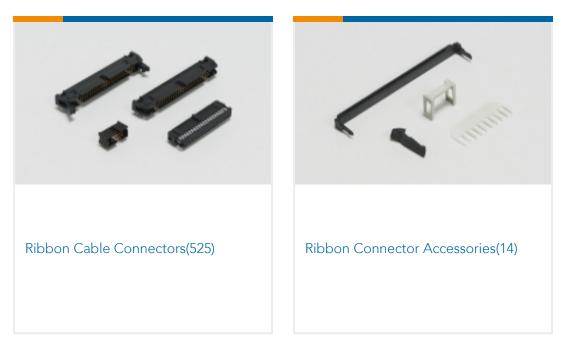
chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

# **Compatible Parts**





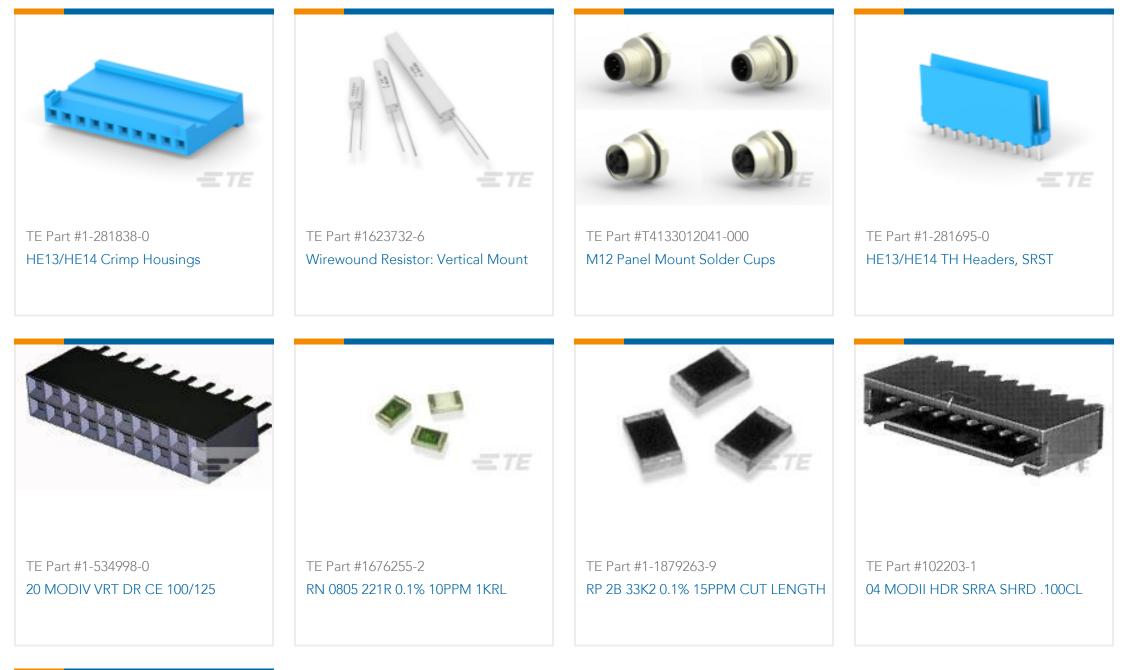
# Also in the Series AMP-LATCH Universal Headers



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# Customers Also Bought





MICRO MNL RFECEPT HSG SINGLE R

## Documents

Product Drawings A/L UNIV HDR 40P VERT LG LAT B

English

**CAD** Files

3D PDF

3D

Customer View Model ENG\_CVM\_CVM\_2-5499206-9\_C.2d\_dxf.zip

English

Customer View Model

ENG\_CVM\_CVM\_2-5499206-9\_C.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_2-5499206-9\_C.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

**S** For support call+1 800 522 6752

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Product Specifications Product Specification

English

Agency Approvals UL Report

English